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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Jae Hak Yee	03/13/2008
Frederick Cruz Santos	03/13/2008
Yong Yong Xia	03/13/2008
Jun Jie Xu	03/13/2008

RECEIVING PARTY DATA

Name:	STATS ChipPAC Ltd.
Street Address:	5 Yishun Street 23
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	768442

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12043789

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 27-469

NAME OF SUBMITTER: Mikio Ishimaru

Total Attachments: 3

PATENT REEL: 020700 FRAME: 0134

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> PATENT REEL: 020700 FRAME: 0135

Docket No.: 27-469

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGE SYSTEM WITH STACKED DEVICES

for which United States patent application serial number 12/043,789 has been executed on or before the date of this assignment;

WHEREAS, <u>STATS ChipPAC Ltd.</u>, a Corporation of the <u>Republic of Singapore</u>, having a place of business at <u>5 Yishun Street 23</u>, <u>Singapore 768442</u> (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

- 1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

1 of 3

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

TH You TH	Mar. 13. 108
Jae Hak Yee	Date
Clark.	展
Witness Signature	Witness Signature
Chin Chee Keong	Shen Guo Qiang
Print Witness Name	Print Witness Name
Mar 13'08	Mar. 13.08
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

	Mar. 13, 2008
Frederick Cruz Santos	Date
冯弘梅	की वे वेवें
Witness Signature	Witness Signature
Feng Yu Feng	Liu Wen Bin
Print Witness Name	Print Witness Name
Mar 13.08	Mor. 13. 08
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

夏水	Mar. 13.08
Yong Yong Xia	Date
进和双军	D 20 3
Witness Signature	Witness Signature
Yao Feng	Wang Ya Ping
Print Witness Name	Print Witness Name
Mar. 13.08	Mar. 13.08
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

净俊杰	Mar. 13. 08
Jun Jie Xu	Date
TEL MAKE	陆运盛
Witness Signature	Witness Signature
Lu Li Hui	Lu Yun Sheng
Print Witness Name	Print Witness Name
Mar. 13.58	Mar. 13. 08
Date	Date